COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

CHIP PACKAGE STRUCTURE AND PROCESS FOR FABRICATING THE SAME

the specification of which									
_	_X is attached hereto was filed on as Application Serial No and was amended on								
a fo a a	pecification, includi I acknowledge pplication in accord	ng the claims the duty to d lance with Tit foreign prio) for patent o ion for paten priority is cla	s, as amer lisclose in tle 37, Coo rity benefi r inventor it or inven	nded by an formation de of Fede its under 's certifica	which is material teral Regulations, § Title 35, United S te listed below and	erred to above. to the patental 1.56(a). tates Code, § have also ide	oility of this 119 of any ntified below		
	Number Country		Date Filed(yyyy/mm/dd)		Yes	No			
	2003-117506	2003-117506 Japan 92129523 Taiwan, R.O.C.		2003/4/22		Х			
	92129523			2003/10/24		Х			
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COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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